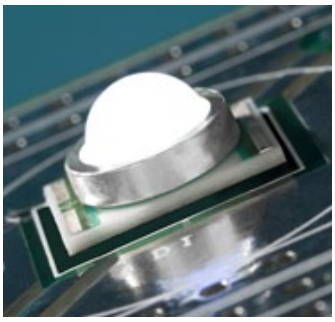
CLD-DS10 REV 12

Cree® XLamp® XR-C LEDs



PRODUCT DESCRIPTION

The XLamp® XR-C LED gives lighting designers the flexibility and performance to create the next generation of LED lighting products. XLamp XR-C LEDs feature electrically neutral thermal path, low thermal resistance and support for a wide range of drive currents.

Cree XLamp LEDs bring high performance and quality of light to a wide range of lighting applications, including color-changing, portable and personal, outdoor, indoor-directional, transportation, stage and studio, commercial and emergency-vehicle lighting.

FEATURES

- Available in white (2600 K to 10,000 K CCT), royal blue, blue, green, amber, red-orange & red
- Maximum drive current: up to 700 mA
- Low thermal resistance: as low as 12 °C/W
- Max junction temperature: 150 °C
- Industry-leading JEDEC standard pre-qualification testing
- Reflow solderable – JEDEC J-STD-020C compatible
- Electrically neutral thermal path
- Lumen maintenance of greater than 70% after 50,000 hours
- RoHS- and REACh-compliant
- UL-recognized component (E349212)

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CHARACTERISTICS - WHITE, ROYAL BLUE, BLUE, GREEN

Characteristics	Unit	Minimum	Typical	Maximum
Thermal resistance, junction to solder point	°C/W		12	
Viewing angle (FWHM) - white	degrees		90	
Viewing angle (FWHM) - royal blue, blue, green	degrees		100	
Temperature coefficient of voltage	mV/°C		-4.0	
ESD classification (HBM per Mil-Std-883D)			Class 2	
DC forward current	mA			500
Reverse voltage	V			5
Forward voltage (@ 350 mA) - white, royal blue, blue	V		3.5	4.0
Forward voltage (@ 350 mA) - green	V		3.7	4.0
Forward voltage (@ 500 mA) - white, royal blue, blue	V		3.6	
LED junction temperature*	°C			150

*** Note: For lumen maintenance data, see the Cree XLamp LED Reliability document.**

CHARACTERISTICS - AMBER, RED-ORANGE, RED

Characteristics	Unit	Minimum	Typical	Maximum
Thermal resistance, junction to solder point	°C/W		15	
Viewing angle (FWHM)	degrees		90	
Temperature coefficient of voltage - red-orange, red	mV/°C		-2.3	
Temperature coefficient of voltage - amber	mV/°C		-1.8	
ESD classification (HBM per Mil-Std-883D)			Class 2	
DC forward current - red-orange, red	mA			700
DC forward current - amber	mA			350
Reverse voltage	V			5
Forward voltage (@ 350 mA)	V		2.2	2.5
Forward voltage (@ 700 mA) - red-orange, red	V		2.4	
LED junction temperature*	°C			150

*** Note: For lumen maintenance data, see the Cree XLamp LED Reliability document.**

FLUX CHARACTERISTICS (T_J = 25 °C) - WHITE

The following tables describe the available colors and flux for XR-C LEDs by listing the correlated color temperature range for the entire family and by providing several base order codes. It is important to note that the base order codes listed here are a subset of the total available order codes for the product family. For more order codes, as well as a complete description of the order-code nomenclature, please consult the XLamp XR LED Family Binning and Labeling document.

Color	CCT Range		Base Order Codes Min Luminous Flux (lm)		Order Code
	Min.	Max.	Group	Flux (lm)	
Cool White	5,000 K	10,000 K	N3	56.8	XRCWHT-L1-0000-00501
			N4	62.0	XRCWHT-L1-0000-00601
			P2	67.2	XRCWHT-L1-0000-00701
			P3	73.9	XRCWHT-L1-0000-00801
			P4	80.6	XRCWHT-L1-0000-00901
			Q2	87.4	XRCWHT-L1-0000-00A01
Neutral White	3,700 K	5,000 K	N3	56.8	XRCWHT-L1-0000-005E4
			N4	62.0	XRCWHT-L1-0000-006E4
			P2	67.2	XRCWHT-L1-0000-007E4
			P3	73.9	XRCWHT-L1-0000-008E4
			P4	80.6	XRCWHT-L1-0000-009E4
Warm White	2,600 K	3,700 K	M3	45.7	XRCWHT-L1-0000-003E7
			N2	51.7	XRCWHT-L1-0000-004E7
			N3	56.8	XRCWHT-L1-0000-005E7
			N4	62.0	XRCWHT-L1-0000-006E7
			P2	67.2	XRCWHT-L1-0000-007E7

Notes:

- Cree maintains a tolerance of ±7% on flux and power measurements, ±0.005 on chromaticity (CCx, CCy) measurements and ±2 on CRI measurements. See the Measurements section (page 12).
- Typical CRI for Cool White & Neutral White (3,700 K – 10,000 K CCT) is 75.
- Typical CRI for Warm White (2,600 K – 3,700 K CCT) is 80.

FLUX CHARACTERISTICS (T_J = 25 °C) - COLOR

Color	Dominant Wavelength Range				Base Order Codes Min. Radiant Flux (mW)		Order Code
	Min.		Max.				
	Group	DWL (nm)	Group	DWL (nm)	Group	Flux (mW)	
Royal Blue	D3	450	D5	465	12	250	XRCROY-L1-0000-00701
					13	300	XRCROY-L1-0000-00801

FLUX CHARACTERISTICS (T_J = 25 °C) - COLOR (CONTINUED)

Color	Dominant Wavelength Range				Base Order Codes Min. Luminous Flux (lm)		Order Code
	Min.		Max.				
	Group	DWL (nm)	Group	DWL (nm)	Group	Flux (lm)	
Blue	B3	465	B4	475	G	13.9	XRCBLU-L1-0000-00G01
					H	18.1	XRCBLU-L1-0000-00H01

Color	Dominant Wavelength Range				Base Order Codes Min. Luminous Flux (lm)		Order Code
	Min.		Max.				
	Group	DWL (nm)	Group	DWL (nm)	Group	Flux (lm)	
Green	G2	520	G4	535	M	39.8	XRCGRN-L1-0000-00M01
					N	51.7	XRCGRN-L1-0000-00N01

Color	Dominant Wavelength Range				Base Order Codes Min. Luminous Flux (lm)		Order Code
	Min.		Max.				
	Group	DWL (nm)	Group	DWL (nm)	Group	Flux (lm)	
Amber	A2	585	A3	595	J	23.5	XRCAMB-L1-0000-00J01
					K2	30.6	XRCAMB-L1-0000-00K01
					M2	39.8	XRCAMB-L1-0000-00M01

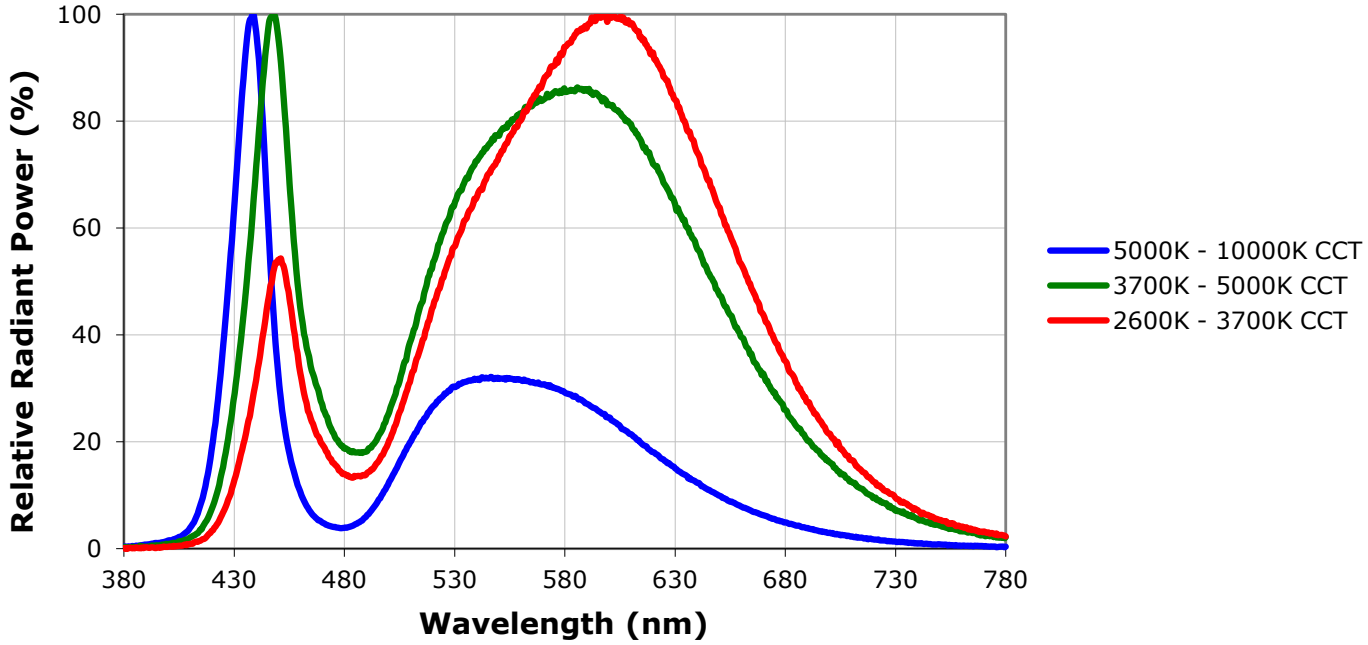
Color	Dominant Wavelength Range				Base Order Codes Min. Luminous Flux (lm)		Order Code
	Min.		Max.				
	Group	DWL (nm)	Group	DWL (nm)	Group	Flux (lm)	
Red-Orange	O3	610	O4	620	K2	30.6	XRCRDO-L1-0000-00K01
					M2	39.8	XRCRDO-L1-0000-00M01

Color	Dominant Wavelength Range				Base Order Codes Min. Luminous Flux (lm)		Order Code
	Min.		Max.				
	Group	DWL (nm)	Group	DWL (nm)	Group	Flux (lm)	
Red	R2	620	R3	630	J	23.5	XRCRED-L1-0000-00J01
					K2	30.6	XRCRED-L1-0000-00K01
					M2	39.8	XRCRED-L1-0000-00M01

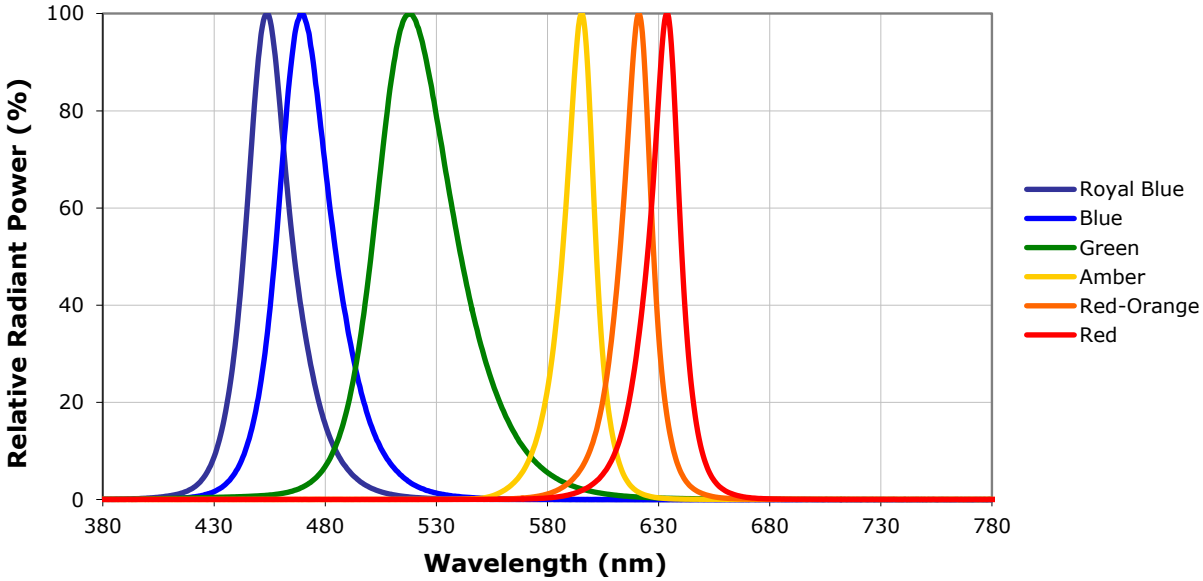
Note: Cree maintains a tolerance of ±7% on flux and power measurements, ±0.005 on chromaticity (CCx, CCy) measurements, ±2 on CRI measurements and ±1 nm on dominant wavelength measurements. See the Measurements section (page 12).

RELATIVE SPECTRAL POWER DISTRIBUTION

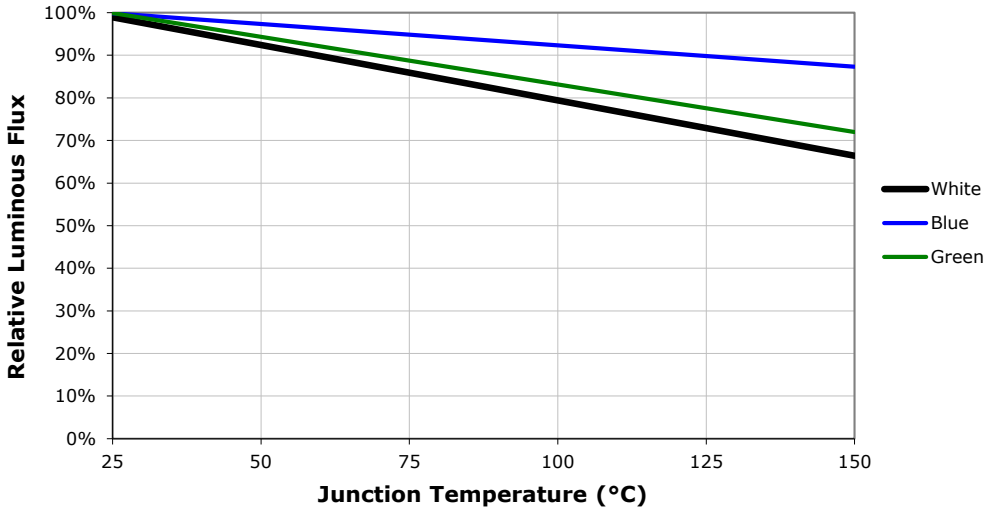
White

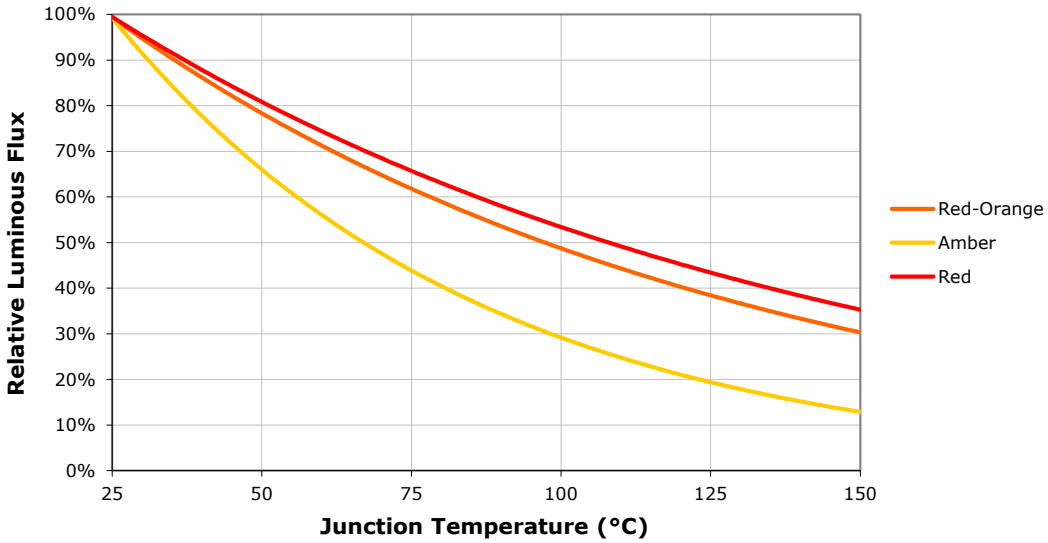


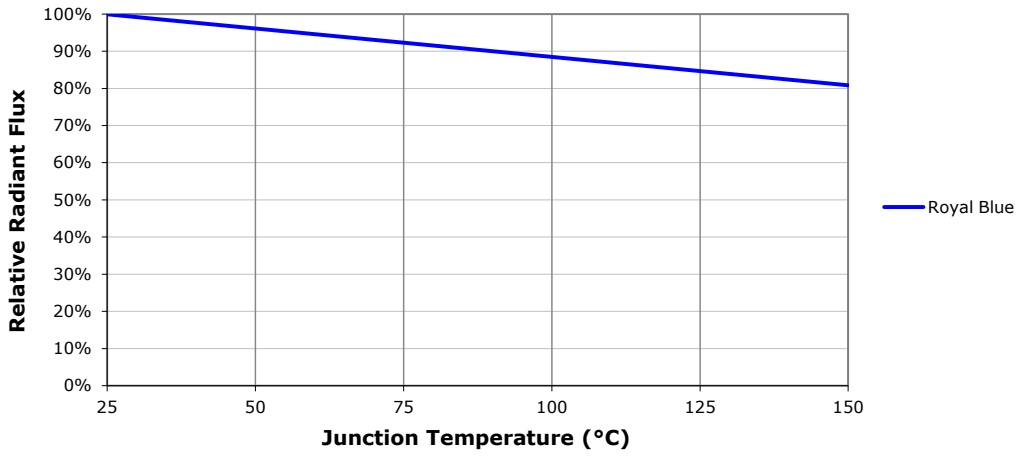
Color



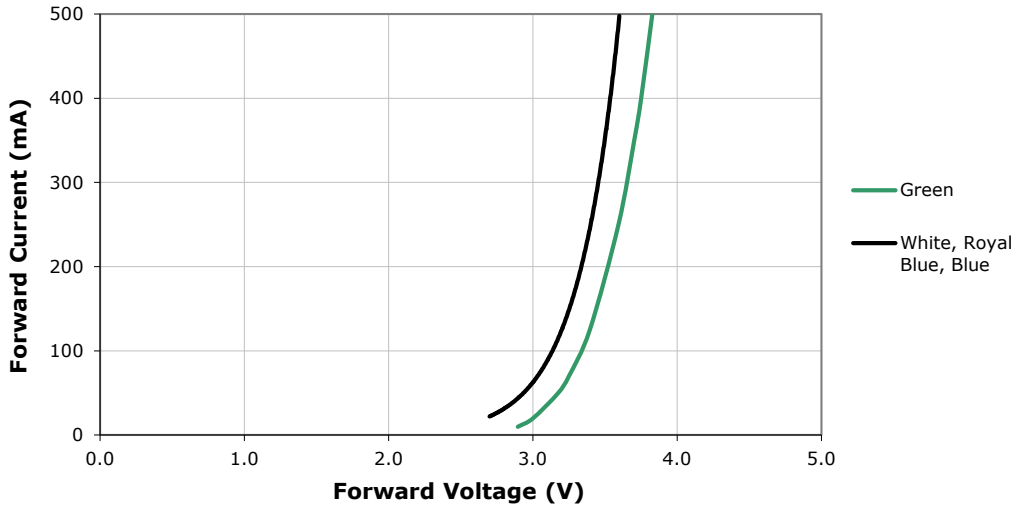
RELATIVE FLUX VS. JUNCTION TEMPERATURE (I_F = 350 mA)

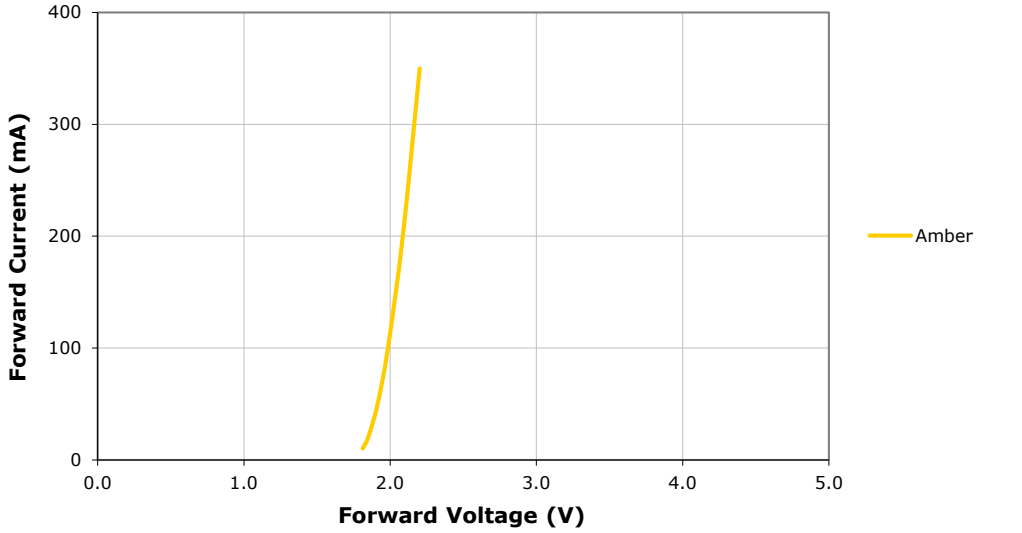


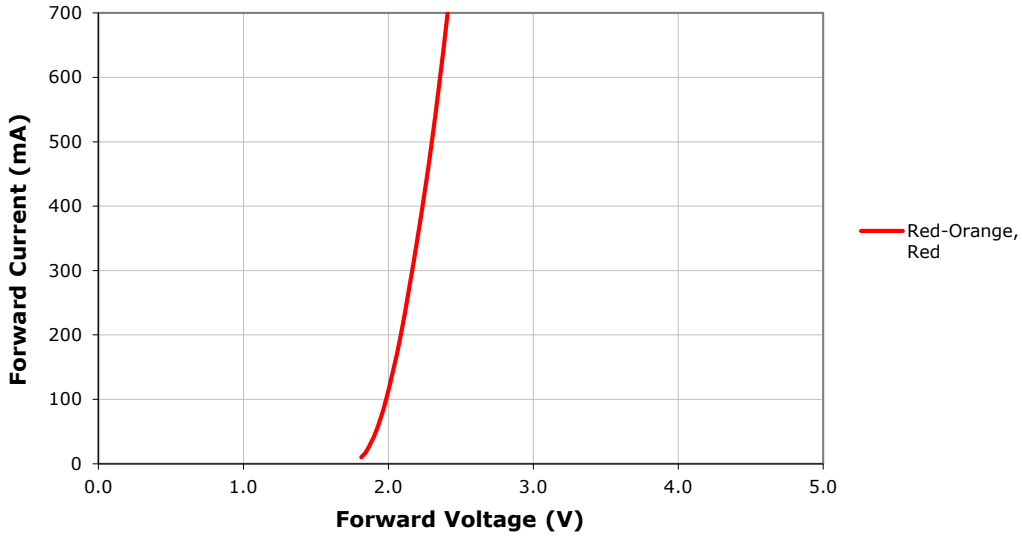




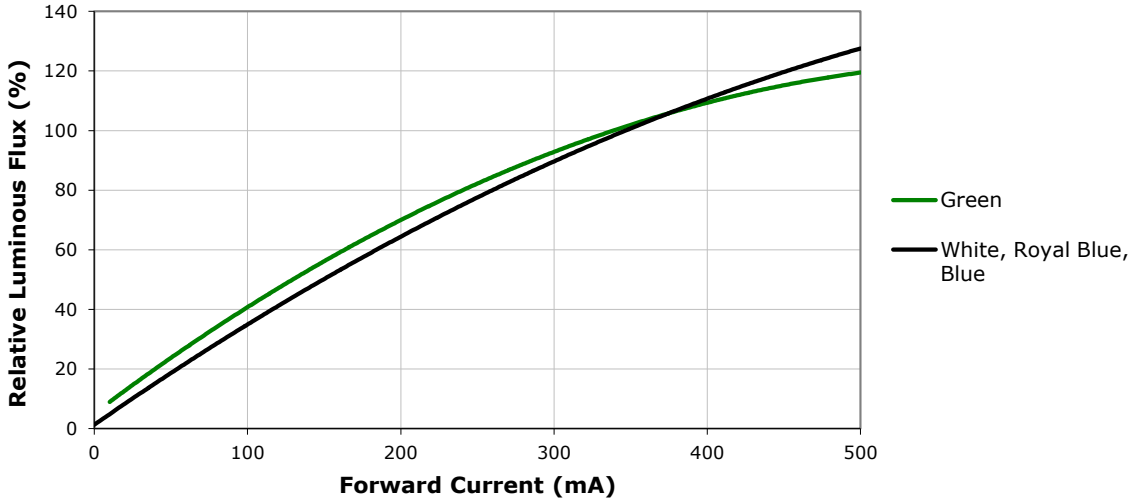
ELECTRICAL CHARACTERISTICS (T_J = 25 °C)

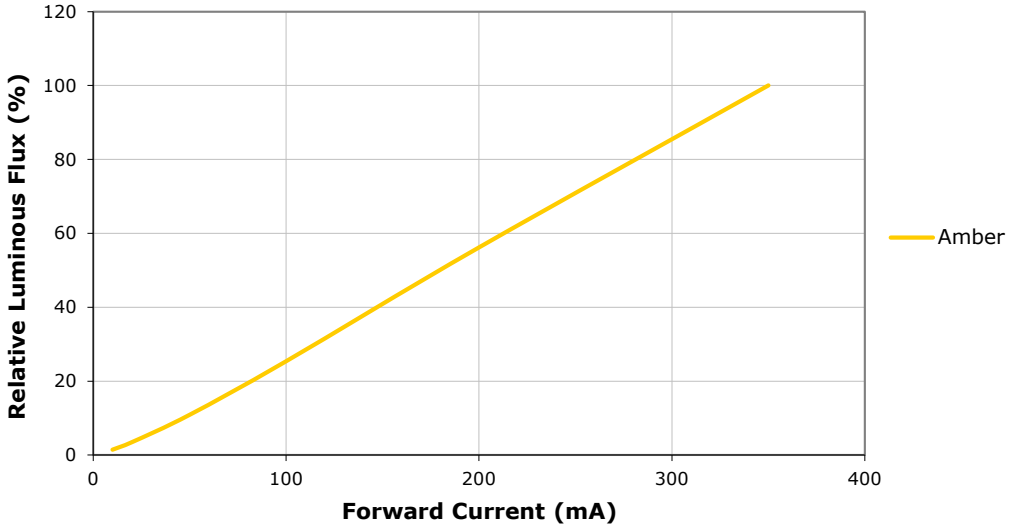


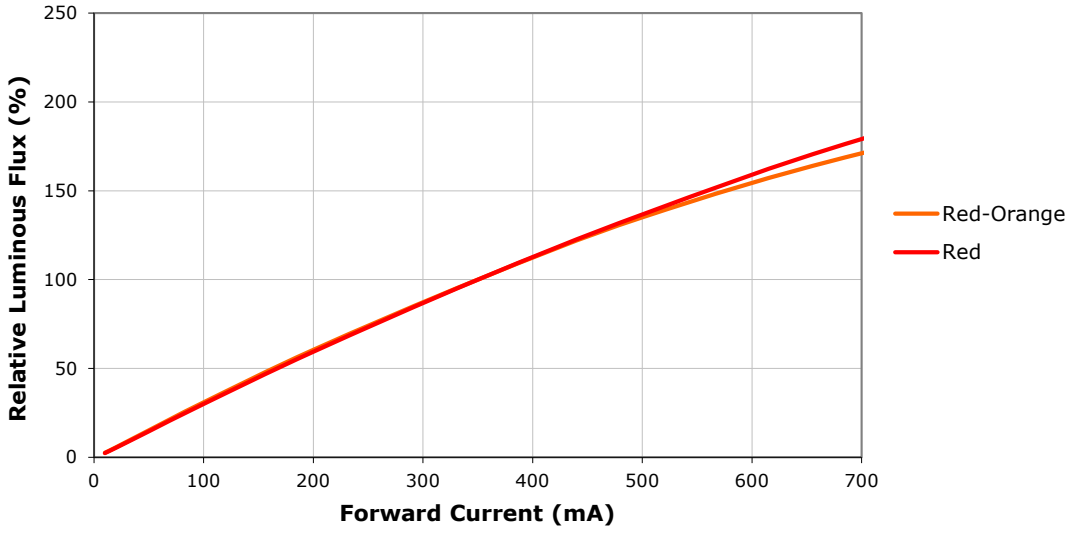




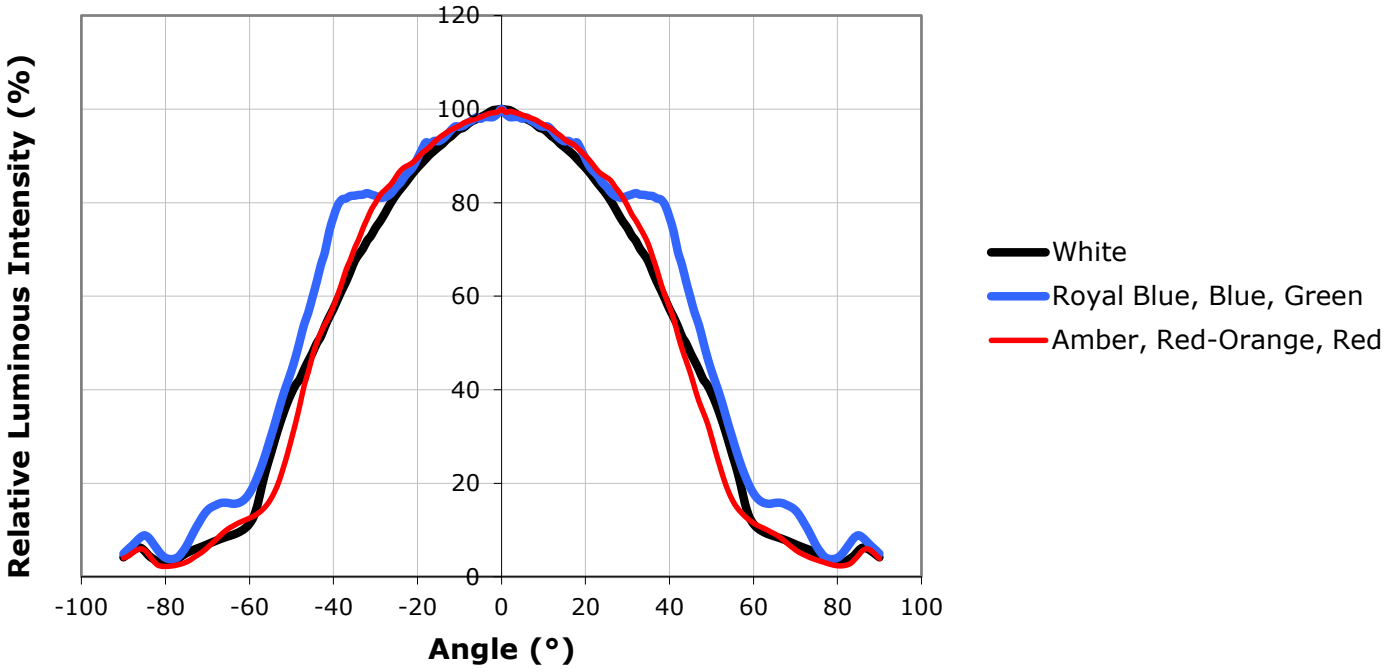
RELATIVE FLUX VS. CURRENT (T_J = 25 °C)







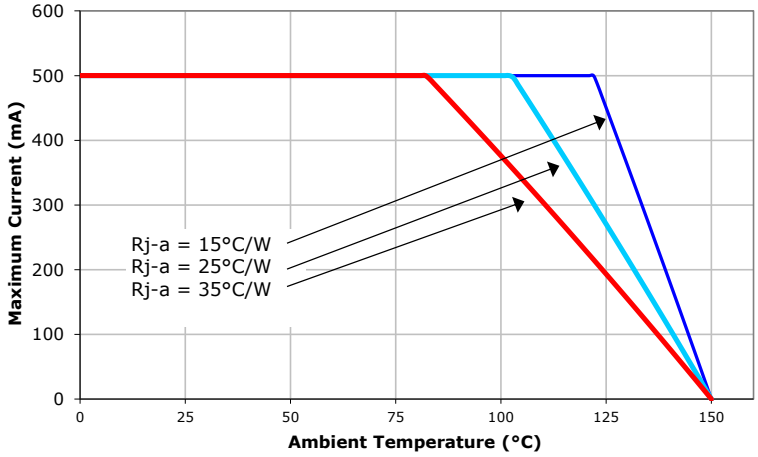
TYPICAL SPATIAL DISTRIBUTION



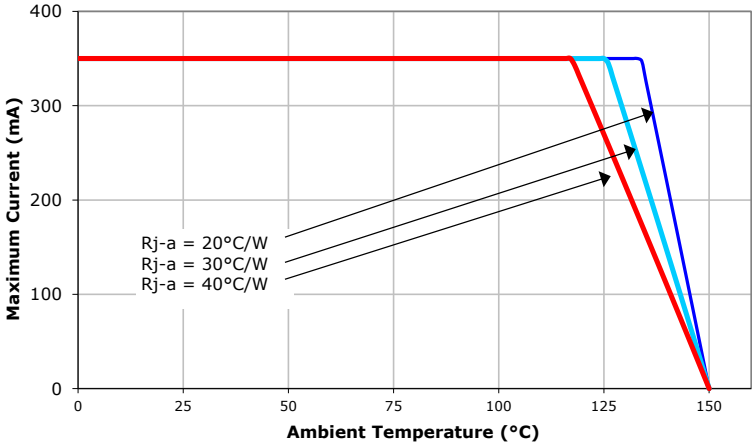
THERMAL DESIGN

The maximum forward current is determined by the thermal resistance between the LED junction and ambient. Given an existing thermal resistance of 12 °C/W or 15 °C/W between the junction and the solder point, it is crucial for the end product to be designed in a manner that minimizes the thermal resistance from the solder point to ambient in order to optimize lamp life and optical characteristics.

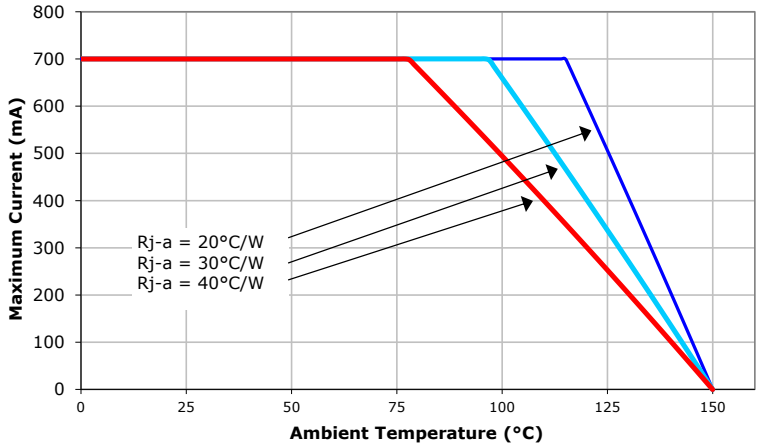
White
Royal Blue
Blue
Green



Amber



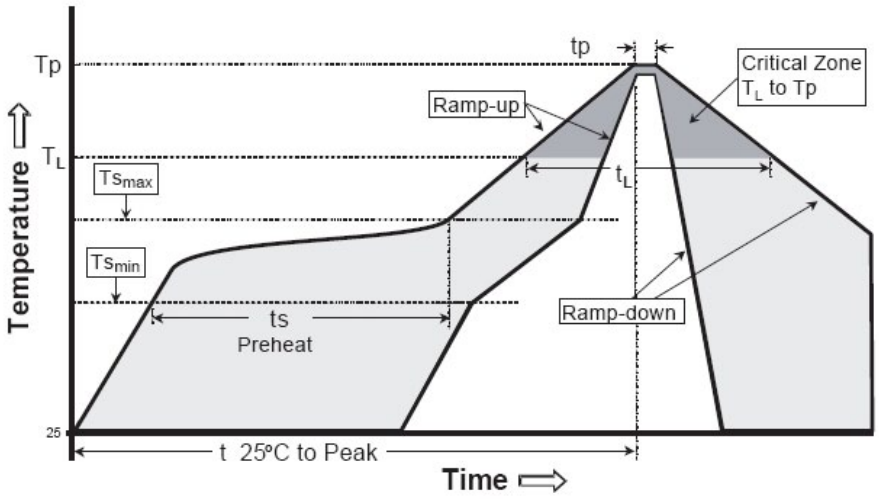
Red-Orange
Red



REFLOW SOLDERING CHARACTERISTICS

In testing, Cree has found XLamp XR-C LEDs to be compatible with JEDEC J-STD-020C, using the parameters listed below. As a general guideline, Cree recommends that users follow the recommended soldering profile provided by the manufacturer of solder paste used.

Note that this general guideline may not apply to all PCB designs and configurations of reflow soldering equipment.



Profile Feature	Lead-Based Solder	Lead-Free Solder
Average Ramp-Up Rate (Ts_{max} to Tp)	3 °C/second max.	3 °C/second max.
Preheat: Temperature Min (Ts_{min})	100 °C	150 °C
Preheat: Temperature Max (Ts_{max})	150 °C	200 °C
Preheat: Time (ts_{min} to ts_{max})	60-120 seconds	60-180 seconds
Time Maintained Above: Temperature (T_L)	183 °C	217 °C
Time Maintained Above: Time (t_L)	60-150 seconds	60-150 seconds
Peak/Classification Temperature (Tp)	215 °C	260 °C
Time Within 5 °C of Actual Peak Temperature (tp)	10-30 seconds	20-40 seconds
Ramp-Down Rate	6 °C/second max.	6 °C/second max.
Time 25 °C to Peak Temperature	6 minutes max.	8 minutes max.

Note: All temperatures refer to topside of the package, measured on the package body surface.

NOTES

Measurements

The luminous flux, radiant power, chromaticity and CRI measurements in this document are binning specifications only and solely represent product measurements as of the date of shipment. These measurements will change over time based on a number of factors that are not within Cree's control and are not intended or provided as operational specifications for the products. Calculated values are provided for informational purposes only and are not intended as specifications.

Lumen Maintenance

Cree now uses standardized IES LM-80-08 and TM-21-11 methods for collecting long-term data and extrapolating LED lumen maintenance. For information on the specific LM-80 data sets available for this LED, refer to the public LM-80 results document.

Please read the Long-Term Lumen Maintenance application note for more details on Cree's lumen maintenance testing and forecasting. Please read the Thermal Management application note for details on how thermal design, ambient temperature, and drive current affect the LED junction temperature.

Moisture Sensitivity

Cree recommends keeping XLamp XR-C LEDs in the provided, resealable moisture-barrier packaging (MBP) until immediately prior to soldering. Unopened MBPs that contain XLamp LEDs do not need special storage for moisture sensitivity.

Once the MBP is opened, XLamp XR-C LEDs should be handled and stored as MSL 4 per JEDEC J-STD-033, meaning they have limited exposure time before damage to the LED may occur during the soldering operation. The table on the right specifies the maximum exposure time in days depending on temperature and humidity conditions. LEDs with exposure time longer than the specified maximums must be baked according to the baking conditions listed below.

Temp.	Maximum Percent Relative Humidity						
	30%	40%	50%	60%	70%	80%	90%
30 ºC	9	5	4	3	1	1	1
25 ºC	12	7	5	4	2	1	1
20 ºC	17	9	7	6	2	2	1

Baking Conditions

It is not necessary to bake all XLamp LEDs. Only the LEDs that meet all of the following criteria must be baked:

- LEDs that have been removed from the original MBP.
- LEDs that have been exposed to a humid environment longer than listed in the Moisture Sensitivity section above.
- LEDs that have not been soldered.

LEDs should be baked at 80 ºC for 24 hours. LEDs may be baked on the original reels. Remove LEDs from the MBP before baking. Do not bake parts at temperatures higher than 80 ºC. This baking operation resets the exposure time as defined in the Moisture Sensitivity section above.

NOTES - CONTINUED

Storage Conditions

XLamp LEDs that have been removed from the original MBP but not soldered yet should be stored in a room or cabinet that will maintain an atmosphere of 25 ± 5 ºC and no greater than 10% RH (relative humidity). For LEDs stored in these conditions, storage time does not add to exposure time as defined in the Moisture Sensitivity section above.

RoHS Compliance

The levels of RoHS restricted materials in this product are below the maximum concentration values (also referred to as the threshold limits) permitted for such substances, or are used in an exempted application, in accordance with EU Directive 2011/65/EC (RoHS2), as implemented January 2, 2013. RoHS Declarations for this product can be obtained from your Cree representative or from the Product Documentation sections of www.cree.com.

REACh Compliance

REACh substances of high concern (SVHCs) information is available for this product. Since the European Chemical Agency (ECHA) has published notice of their intent to frequently revise the SVHC listing for the foreseeable future, please contact a Cree representative to insure you get the most up-to-date REACh SVHC Declaration. REACh banned substance information (REACh Article 67) is also available upon request.

Vision Advisory

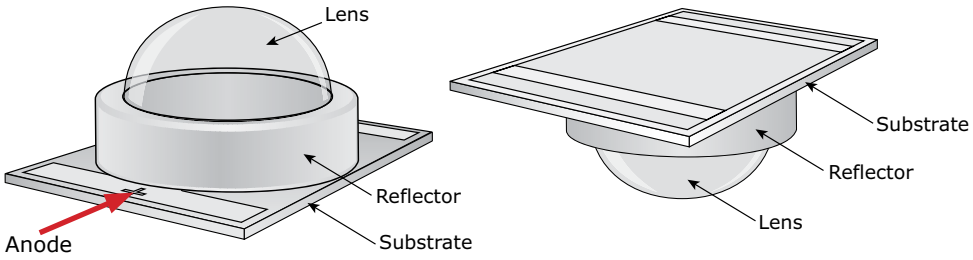
WARNING: Do not look at an exposed lamp in operation. Eye injury can result. For more information about LEDs and eye safety, please refer to the LED Eye Safety application note.

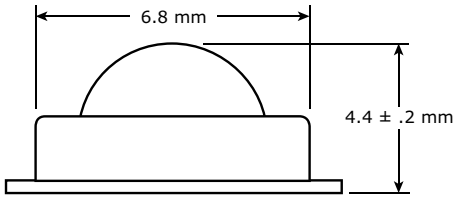
Intellectual Property

For remote phosphor applications, a separate license to certain Cree patents is required.

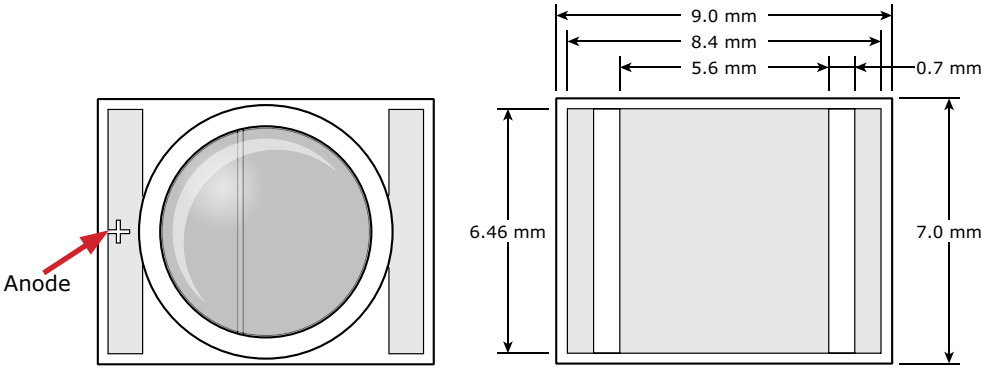
MECHANICAL DIMENSIONS (TA = 25 °C)

All measurements are ±.1 mm unless otherwise indicated.



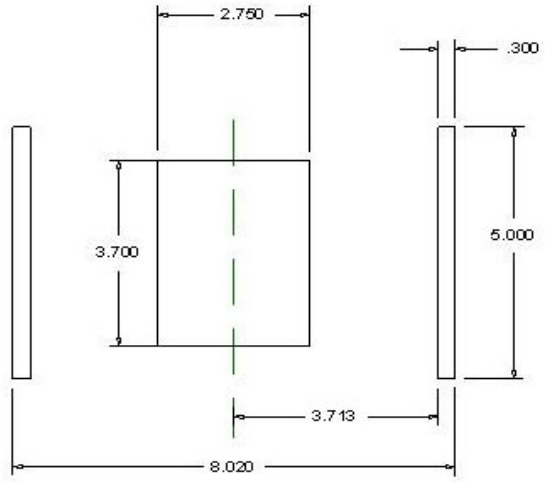


Side View



Top View

Bottom View

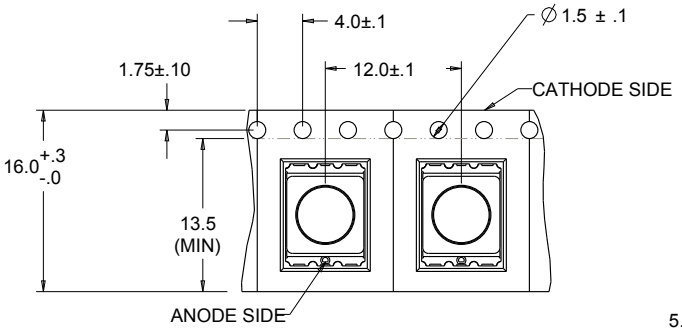


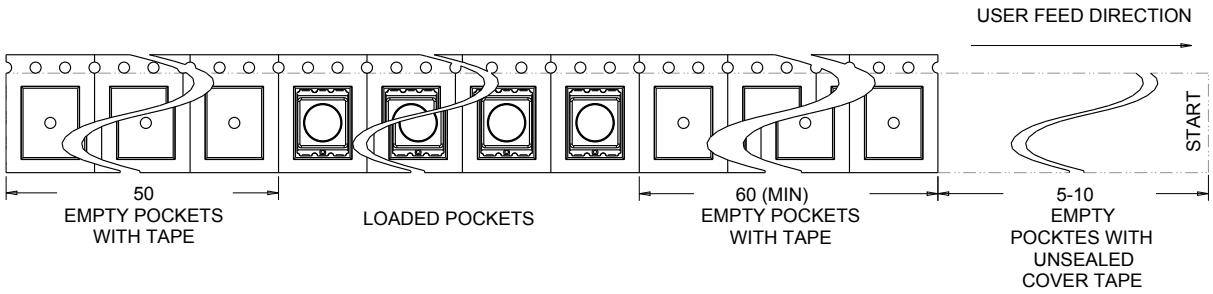
Recommended PC Board Solder Pad

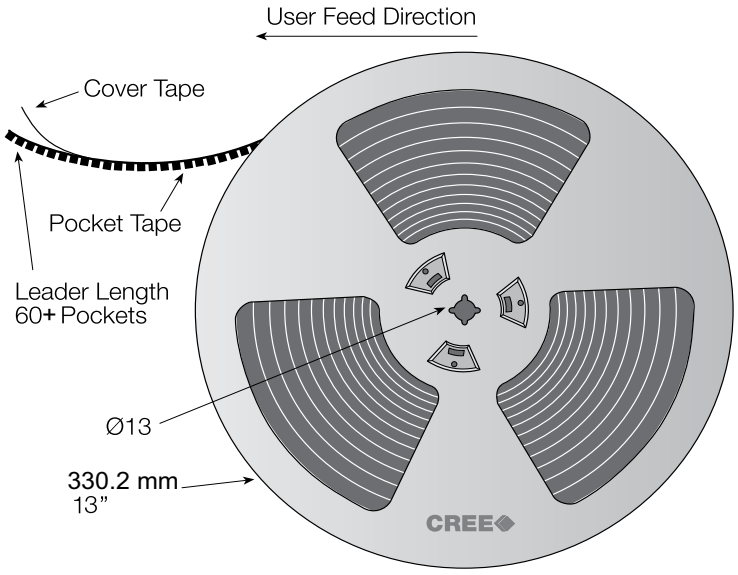
TAPE AND REEL

All Cree carrier tapes conform to EIA-481D, Automated Component Handling Systems Standard.

All dimensions in mm.

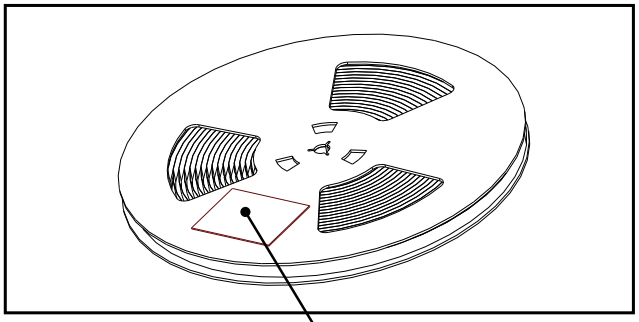




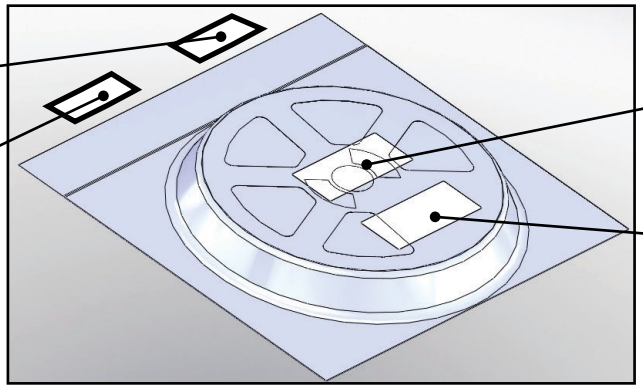


DRY PACKAGING AND PACKAGING

Unpackaged Reel



Packaged Reel



Boxed Reel